Onsemi

IGBT - Ultra Field Stop NGTB40N120L3WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for motor driver applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for Low V_{CEsat}
- These are Pb-Free Devices

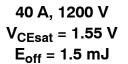
Typical Applications

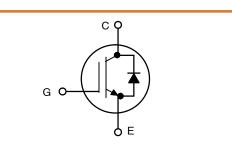
- Solar Inverter and UPS
- Industrial Switching
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter Voltage	V _{CES}	1200	V
Collector Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _C	160 40	A
Pulsed Collector Current, T _{pulse} Limited by T _{Jmax}	I _{CM}	160	A
Diode Forward Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	l _F	160 40	A
Diode Pulsed Current, T _{pulse} Limited by T _{Jmax}	I _{FM}	160	A
Gate-emitter Voltage Transient Gate-emitter Voltage ($t_{pulse} = 5 \ \mu s, D < 0.10$)	V _{GE}	±20 ±30	V
Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	P _D	454 227	W
Operating Junction Temperature Range	TJ	–55 to +175	°C
Storage Temperature Range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

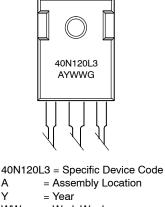
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







MARKING DIAGRAM



WW = Work Week

А Υ

G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB40N120L3WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.33	°C/W
Thermal resistance junction-to-case, for Diode		0.61	°C/W
Thermal resistance junction-to-ambient		40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

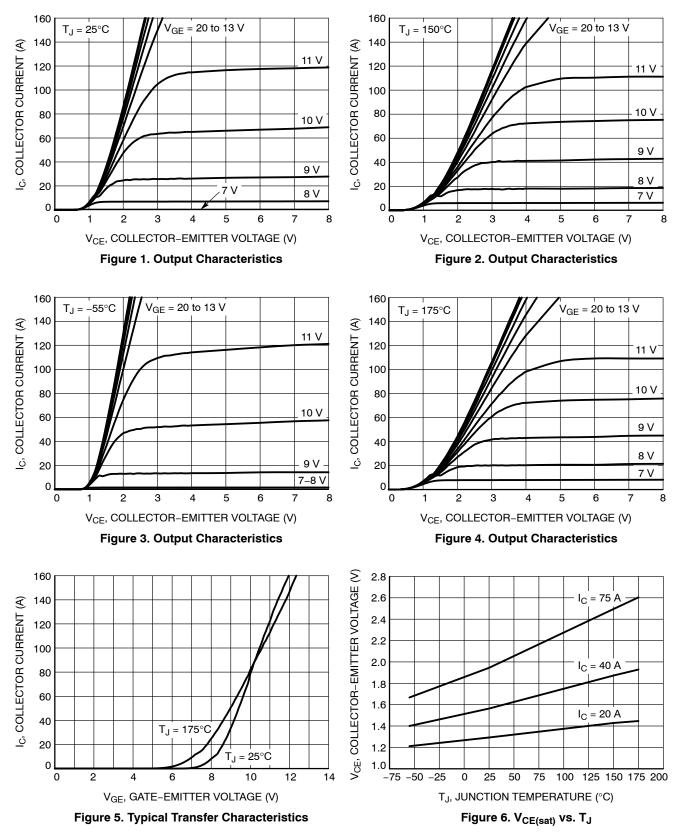
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC		-		-	-	-
Collector-emitter breakdown voltage, gate-emitter short-circuited			1200	-	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}		1.55 2.0	1.8 _	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V_{GE} = 0 V, V_{CE} = 1200 V V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 175°C	I _{CES}	-	_ 0.5	0.4	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	-	_	200	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		Cies	-	4912	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	_	140	-	
Reverse transfer capacitance		C _{res}	-	80	-	1
Gate charge total		Qg	-	220	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	42	-	-
Gate to collector charge		Q _{gc}	-	110	-	
SWITCHING CHARACTERISTIC, INDUCT	IVE LOAD					
Turn-on delay time		t _{d(on)}	_	18	-	ns
Rise time		tr	_	30	_	
Turn-off delay time	T _J = 25°C	t _{d(off)}	_	150	-	
Fall time	$V_{CC} = 600 \text{ V}, I_{C} = 40 \text{ A}$	t _f	-	131	-	
Turn-on switching loss	$R_g = 10 \Omega$ V _{GE} = 15 V	Eon	_	1.5	-	mJ
Turn-off switching loss		E _{off}	-	1.5	-	
Total switching loss		E _{ts}	-	3.0	-	
Turn-on delay time		t _{d(on)}	-	18	-	ns
Rise time		t _r	-	31	-	
Turn-off delay time	T _J = 175°C	t _{d(off)}	-	156	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $\text{R}_{g} = 10 \Omega$	t _f	-	220	-	
Turn-on switching loss	$V_{GE} = 15 V$	Eon	-	2.0	-	mJ
Turn-off switching loss		E _{off}	-	2.3	-	-
Total switching loss		E _{ts}	-	4.3	-	
DIODE CHARACTERISTICS						
Forward voltage	V _{GE} = 0 V, I _F = 40 A V _{GE} = 0 V, I _F = 40 A T _{J =} 175°C	V _F	-	3.0 2.8	3.4 _	V
Reverse recovery time		t _{rr}	-	86	-	ns
Reverse recovery charge	T _J = 25°C	Q _{rr}	-	0.56	-	μC
Reverse recovery current	$I_{\rm F} = 40$ Å, $V_{\rm R} = 600$ V	I _{rrm}	-	12	-	A
Diode peak rate of fall of reverse recovery current during tb	di _F /dt = 500 A/µs	dl _{rrm} /dt	_	-210	_	A/μs

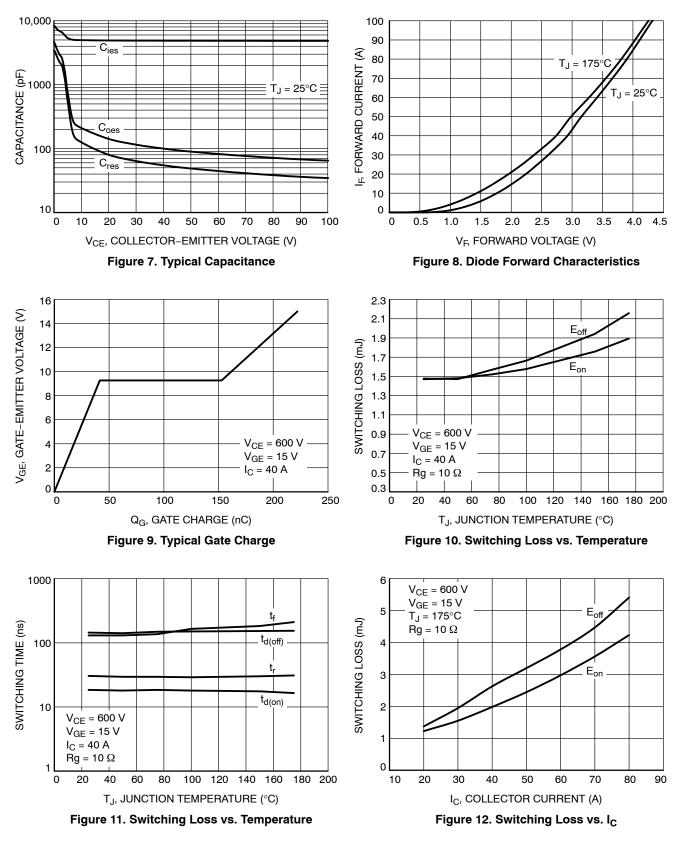
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

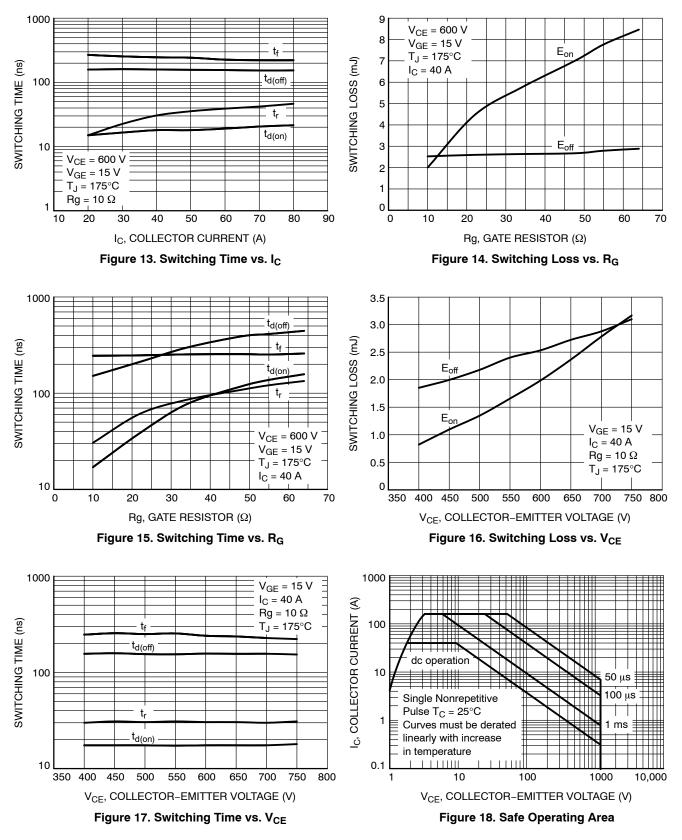
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTICS						
Reverse recovery time		t _{rr}	-	136	-	ns
Reverse recovery charge	T _J = 125°C	Q _{rr}	-	1.47	-	μc
Reverse recovery current	T _J = 125°C I _F = 40 A, V _R = 600 V diϝ/dt = 500 A/μs	I _{rrm}	-	20	-	А
Diode peak rate of fall of reverse recovery current during tb	αι-/αι – 300 Α/μ3	dl _{rrm} /dt	-	-212	-	A/μs

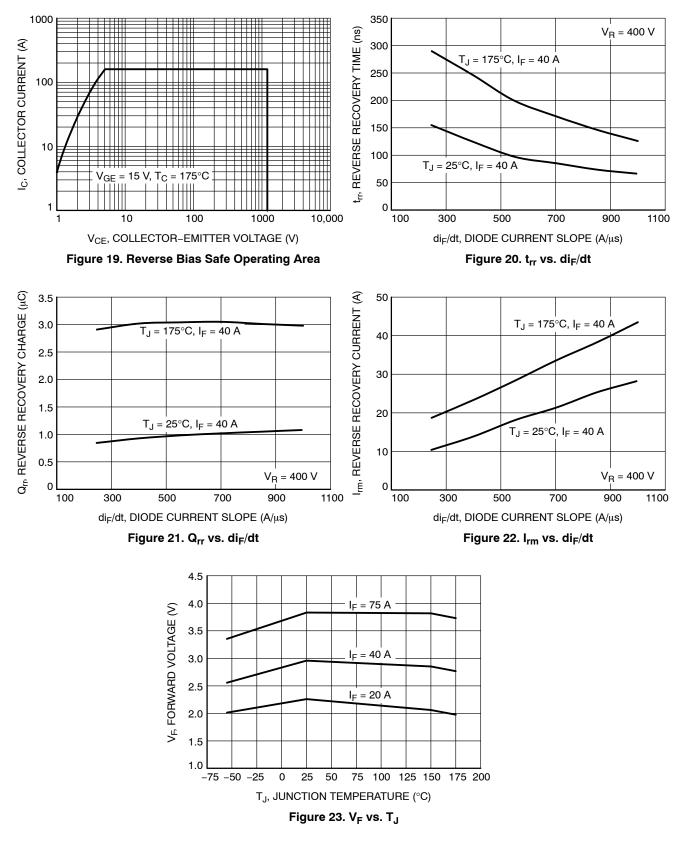
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

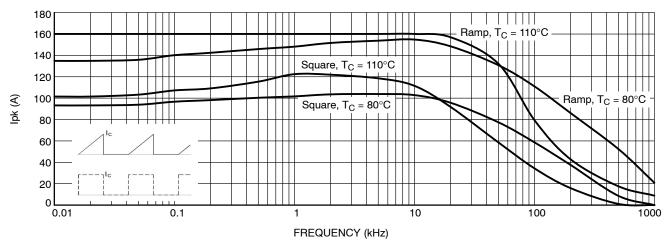




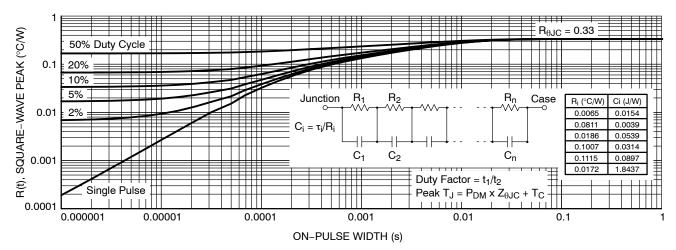


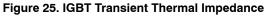


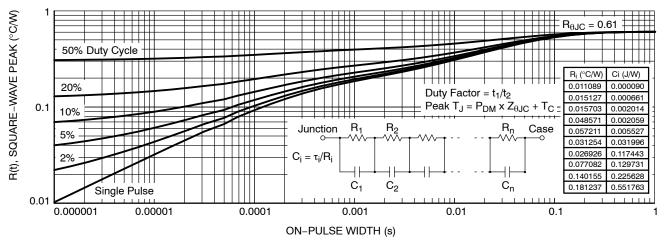














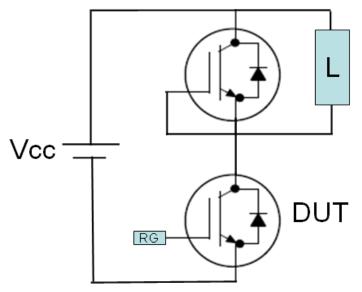


Figure 27. Test Circuit for Switching Characteristics

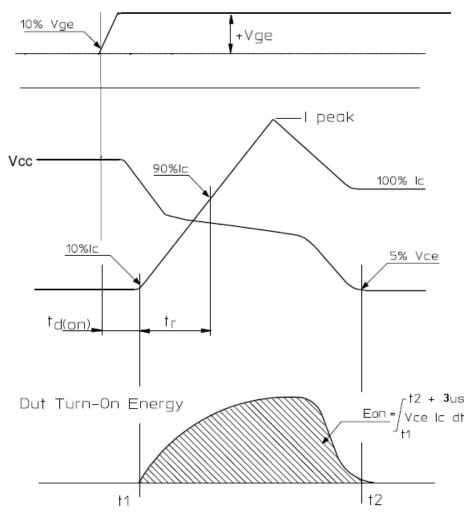


Figure 28. Definition of Turn On Waveform

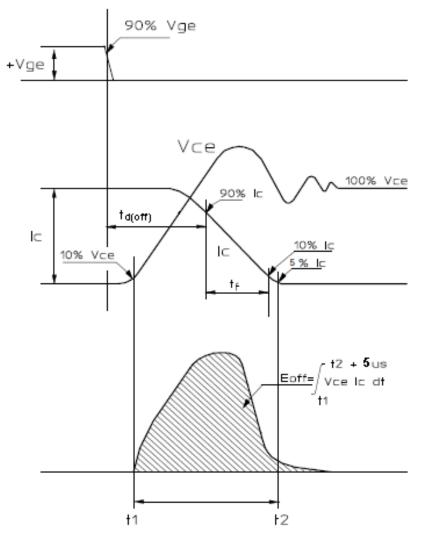
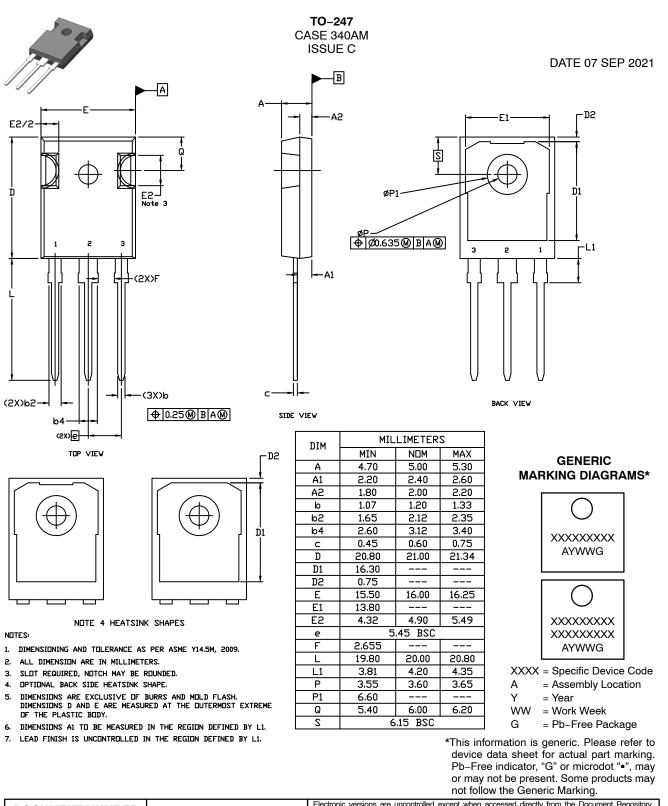


Figure 29. Definition of Turn Off Waveform





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